

Dual N-Channel Enhancement Mode MOSFET

General Description

The CMSC3812A uses advanced trench technology to provide excellent $R_{DS(ON)}$ and low gate charge. The two MOSFETs make a compact and efficient switch and synchronous rectifier combination for use in buck converters.

Features

- Low On-Resistance
- Improved dv/dt capability
- Fast switching
- RoHS Compliant

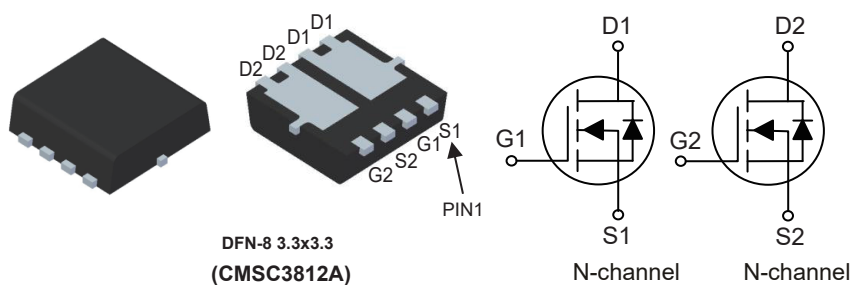
Product Summary

BVDSS	RDSON	ID
30V	22mΩ	20A

Applications

- DC/DC Converters in Computing, Servers, and POL
- Isolated DC/DC Converters in Telecom and Industrial

DFN-8 3.3x3.3 Pin Configuration



Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	30	V
V_{GS}	Gate-Source Voltage	± 20	V
I_D	Continuous Drain Current	20	A
$I_D@T_A=75^\circ\text{C}$	Continuous Drain Current	13	A
I_{DM}	Pulsed Drain Current	80	A
EAS	Single Pulse Avalanche Energy ¹	36	mJ
$P_D@T_C=25^\circ\text{C}$	Total Power Dissipation	25	W
T_{STG}	Storage Temperature Range	-55 to 150	$^\circ\text{C}$
T_J	Operating Junction Temperature Range	-55 to 150	$^\circ\text{C}$

Thermal Data

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction-ambient	---	62	$^\circ\text{C}/\text{W}$
$R_{\theta JC}$	Thermal Resistance Junction-case	---	5	$^\circ\text{C}/\text{W}$

Electrical Characteristics ($T_J=25^{\circ}\text{C}$, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS}=0V$, $I_D=250\mu A$	30	---	---	V
$R_{DS(ON)}$	Static Drain-Source On-Resistance	$V_{GS}=10V$, $I_D=12A$	---	19	22	$m\Omega$
		$V_{GS}=4.5V$, $I_D=10A$	---	36	44	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS}=V_{DS}$, $I_D=250\mu A$	1	---	3	V
I_{DSS}	Drain-Source Leakage Current	$V_{DS}=30V$, $V_{GS}=0V$	---	---	1	μA
		$V_{DS}=24V$, $V_{GS}=0V$, $T_J=125^{\circ}\text{C}$	---	---	10	
I_{GSS}	Gate-Source Leakage Current	$V_{GS}=\pm 20V$	---	---	± 100	nA
g_{fs}	Forward Transconductance	$V_{DS}=5V$, $I_D=10A$	---	9	---	S
Q_g	Total Gate Charge	$V_{DS}=15V$, $I_D=8A$ $V_{GS}=4.5V$	---	4	---	nC
Q_{gs}	Gate-Source Charge		---	1	---	
Q_{gd}	Gate-Drain Charge		---	2.1	---	
$T_{d(on)}$	Turn-On Delay Time	$V_{DD}=15V$, $V_{GS}=10V$, $R_G=6\Omega$ $I_D=1A$	---	3	---	ns
T_r	Rise Time		---	7.5	---	
$T_{d(off)}$	Turn-Off Delay Time		---	16	---	
T_f	Fall Time		---	5	---	
C_{iss}	Input Capacitance	$V_{DS}=25V$, $V_{GS}=0V$, $f=1\text{MHz}$	---	600	---	pF
C_{oss}	Output Capacitance		---	100	---	
C_{rss}	Reverse Transfer Capacitance		---	50	---	

Diode Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I_S	Diode continuous forward current	$V_G=V_D=0V$, Force Current	---	---	20	A
$I_{S,pulse}$	Diode pulse current		---	---	80	A
V_{SD}	Diode Forward Voltage	$V_{GS}=0V$, $I_F=1A$, $T_J=25^{\circ}\text{C}$	---	---	1	V

Notes:

1.The EAS data shows Max. rating .The test condition is $V_{DS}=25V$, $V_{GS}=10V$, $L=0.5mH$, $I_{AS}=12A$.

This product has been designed and qualified for the consumer market.

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Cmos reserves the right to improve product design ,functions and reliability without notice.

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Typical Characteristics

